

MOSFET – Power, Complementary Dual ECH8

60 V, 4.7 A, 55 mΩ
-60 V, -3.5 A, 94 mΩ

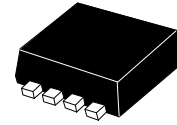
ECH8690

Description

This Power MOSFET is Produced Using onsemi’s Trench Technology, Which is Specifically Designed to Low on Resistance. This devices is suitable for applications with low on resistance requirements.

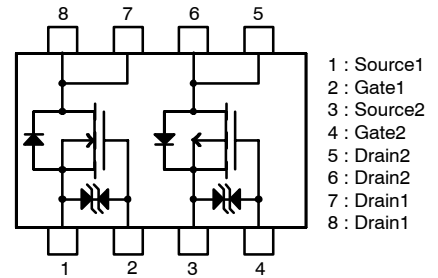
Features

- On-State Resistance
 - ◆ Nch: $R_{DS(on)1} = 42\text{ m}\Omega$ (typ.)
 - ◆ Pch: $R_{DS(on)1} = 73\text{ m}\Omega$ (typ.)
- Protection Diode In
- 4 V rive
- Nch + Pch MOSFET
- This Device is Pb-Free, Halogen Free and RoHS Compliant

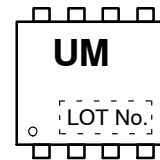


SOT-28FL/ECH8
 CASE 318BF

ELECTRICAL CONNECTION



MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 7 of this data sheet.

ECH8690

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C)

Symbol	Parameter	Conditions	N-Channel	P-Channel	Unit
V _{DSS}	Drain to Source Voltage		60	-60	V
V _{GSS}	Gate to Source Voltage		±20	±20	V
I _D	Drain Current (DC)		4.7	-3.5	A
I _{DP}	Drain Current (Pulse)	PW ≤ 10 μs, duty cycle ≤ 1%	30	-30	A
P _D	Allowable Power Dissipation	When mounted on ceramic substrate (1200 mm ² X 0.8 mm) 1 unit	1.5		W
P _T	Total Dissipation	When mounted on ceramic substrate (1200 mm ² X 0.8 mm)	1.8		W
T _{ch}	Channel Temperature		150		°C
T _{stg}	Storage Temperature		-55 to +150		°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

ELECTRICAL CHARACTERISTICS (T_A = 25°C) (Note 3)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
--------	-----------	------------	-----	-----	-----	------

[N-channel]

V _{(BR)DSS}	Drain to Source Breakdown Voltage	I _D = 1 mA, V _{GS} = 0 V	60	-	-	V
I _{DSS}	Zero-Gate Voltage Drain Current	V _{DS} = 60 V, V _{GS} = 0 V	-	-	1	μA
I _{GSS}	Gate to Source Leakage Current	V _{GS} = ±16 V, V _{DS} = 0 V		-	±10	μA
V _{GS(off)}	Cutoff Voltage	V _{DS} = 10 V, I _D = 1 mA	1.2	-	2.6	V
y _{fs}	Forward Transfer Admittance	V _{DS} = 10 V, I _D = 2 A	-	4.2	-	S
R _{DS(on)1}	Static Drain to Source On-State Resistance	I _D = 2 A, V _{GS} = 10 V	-	42	55	mΩ
R _{DS(on)2}		I _D = 1 A, V _{GS} = 4.5 V	-	53	74	mΩ
R _{DS(on)3}		I _D = 1 A, V _{GS} = 4 V	-	61	85	mΩ
C _{iss}	Input Capacitance	V _{DS} = 20 V, f = 1 MHz	-	955	-	pF
C _{oss}	Output Capacitance		-	58	-	pF
C _{rss}	Reverse Transfer Capacitance		-	45	-	pF
t _{d(on)}	Turn-ON Delay Time	See specified Test Circuit.	-	7	-	ns
t _r	Rise Time		-	8.4	-	ns
t _{d(off)}	Turn-OFF Delay Time		-	76	-	ns
t _f	Fall Time		-	23	-	ns
Q _g	Total Gate Charge	V _{DS} = 30 V, V _{GS} = 10 V, I _D = 4.7 A	-	18	-	nC
Q _{gs}	Gate to Source Charge		-	3	-	nC
Q _{gd}	Gate to Drain "Miller" Charge		-	2.8	-	nC
V _{SD}	Diode Forward Voltage	I _S = 4.7 A, V _{GS} = 0 V	-	0.82	1.2	V

[P-channel]

V _{(BR)DSS}	Drain to Source Breakdown Voltage	I _D = -1 mA, V _{GS} = 0 V	-60	-	-	V
I _{DSS}	Zero-Gate Voltage Drain Current	V _{DS} = -60 V, V _{GS} = 0 V	-	-	-1	μA
I _{GSS}	Gate to Source Leakage Current	V _{GS} = ±16 V, V _{DS} = 0 V		-	±10	μA
V _{GS(off)}	Cutoff Voltage	V _{DS} = -10 V, I _D = -1 mA	-1.2	-	-2.6	V
y _{fs}	Forward Transfer Admittance	V _{DS} = -10 V, I _D = -1.5 A	-	3.4	-	S
R _{DS(on)1}	Static Drain to Source On-State Resistance	I _D = -1 A, V _{GS} = -10 V	-	73	94	mΩ
R _{DS(on)2}		I _D = -0.5 A, V _{GS} = -4.5 V	-	97	135	mΩ
R _{DS(on)3}		I _D = -0.5 A, V _{GS} = 4 V	-	108	153	mΩ

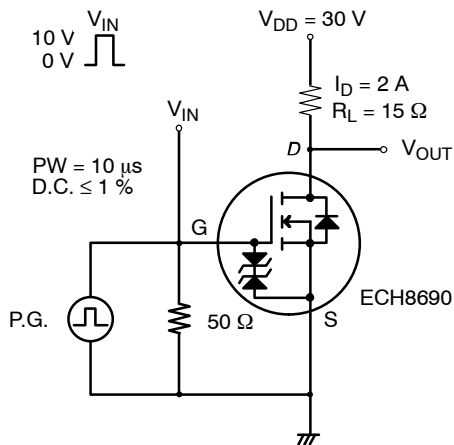
ECH8690

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$) (Note 3) (continued)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
[P-channel]						
C _{iss}	Input Capacitance	$V_{DS} = -20\text{ V}, f = 1\text{ MHz}$	-	790	-	pF
C _{oss}	Output Capacitance		-	63	-	pF
C _{rss}	Reverse Transfer Capacitance		-	45	-	pF
t _{d(on)}	Turn-ON Delay Time	See specified Test Circuit.	-	10	-	ns
t _r	Rise Time		-	8.8	-	ns
t _{d(off)}	Turn-OFF Delay Time		-	84	-	ns
t _f	Fall Time		-	29	-	ns
Q _g	Total Gate Charge		$V_{DS} = -30\text{ V}, V_{GS} = -10\text{ V}, I_D = -3.5\text{ A}$	-	15	-
Q _{gs}	Gate to Source Charge	-		2.6	-	nC
Q _{gd}	Gate to Drain "Miller" Charge	-		2.2	-	nC
V _{SD}	Diode Forward Voltage	$I_S = -3.5\text{ A}, V_{GS} = 0\text{ V}$	-	-0.83	-1.2	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

[N-Channel]



[P-Channel]

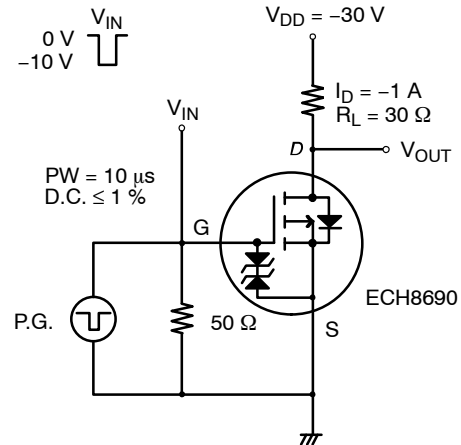


Figure 1. Switching Time Test Circuit

TYPICAL CHARACTERISTICS

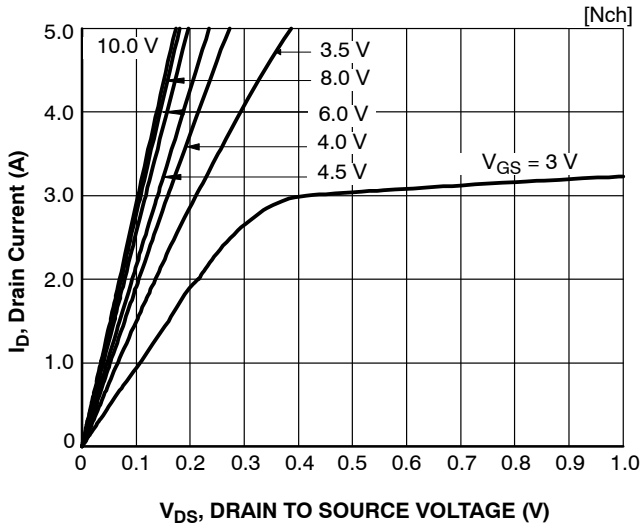


Figure 2. $I_D - V_{DS}$

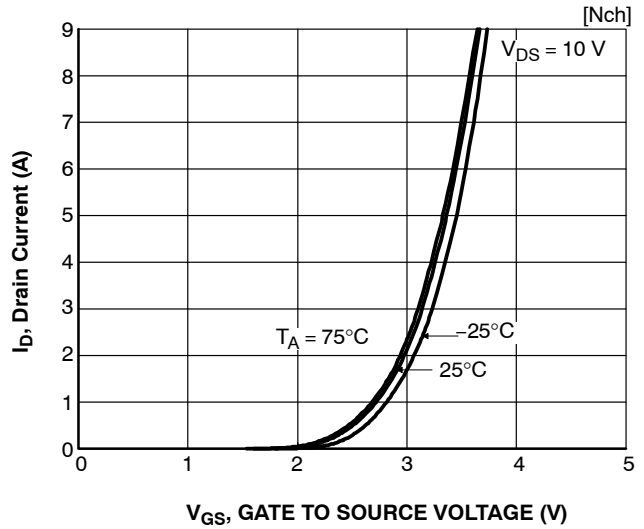


Figure 3. $I_D - V_{GS}$

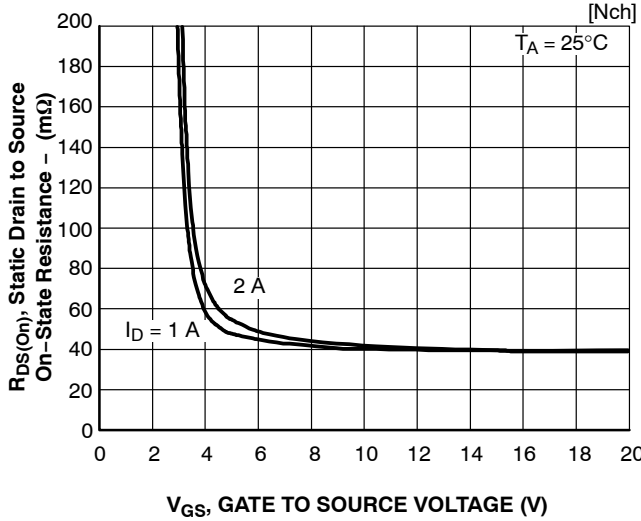


Figure 4. $R_{DS(on)} - V_{GS}$

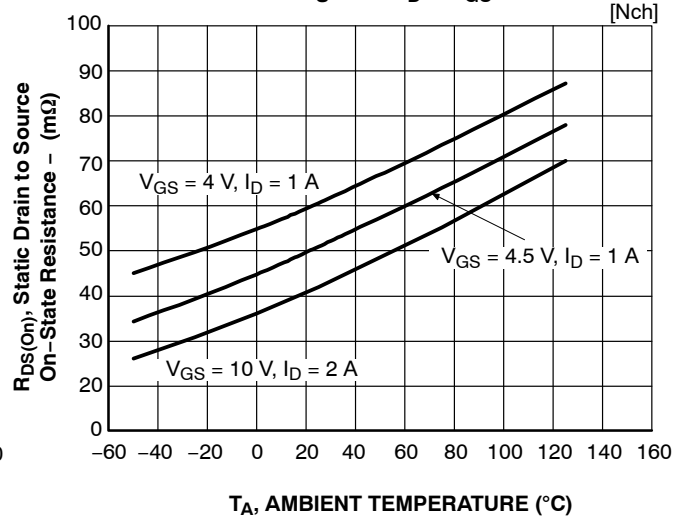


Figure 5. $R_{DS(on)} - T_A$

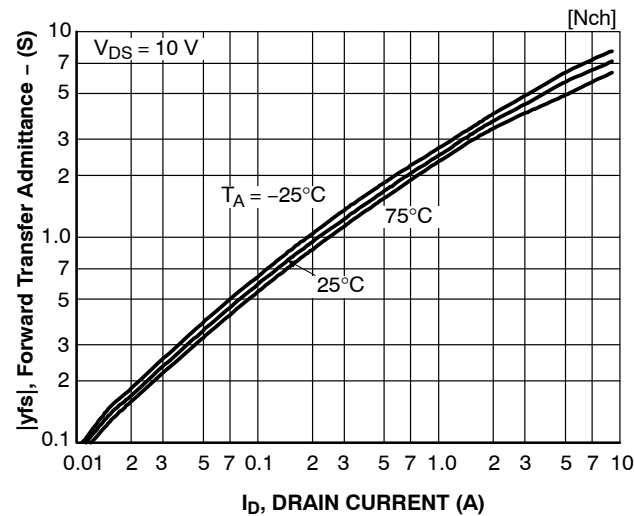


Figure 6. $|Y_{fs}| - I_D$

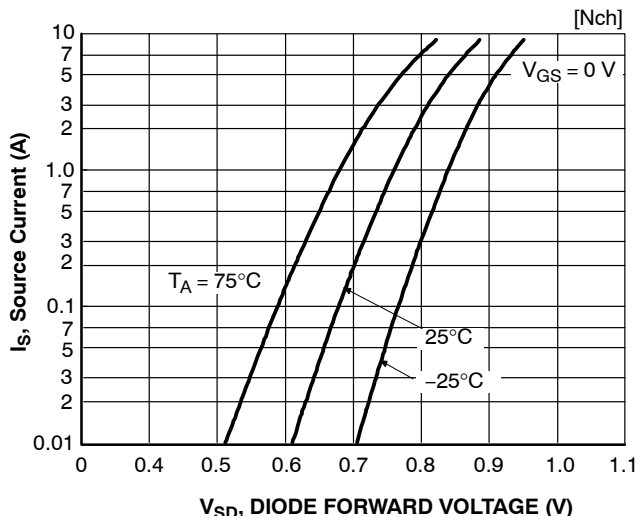


Figure 7. $I_S - V_{SD}$

TYPICAL CHARACTERISTICS (CONTINUED)

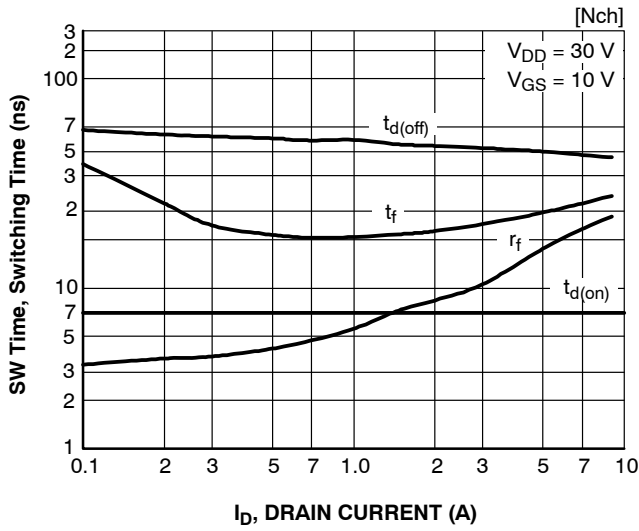


Figure 8. I_D - S/W Time

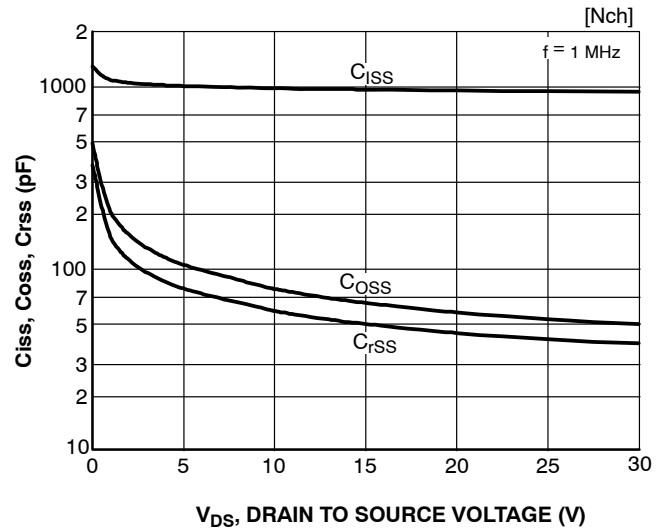


Figure 9. Ciss, Coss, Crss - V_{DS}

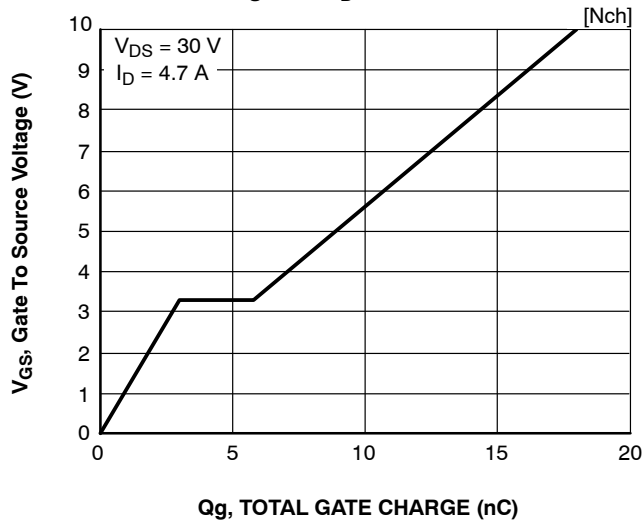


Figure 10. V_{GS} - Q_g

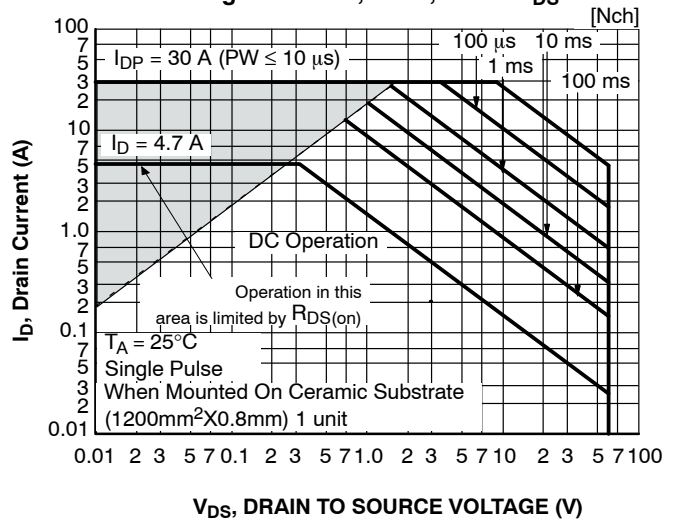


Figure 11. S O A

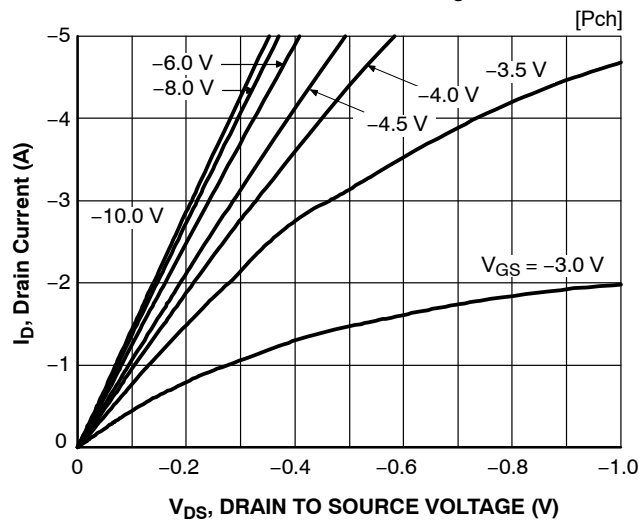


Figure 12. I_D - V_{DS}

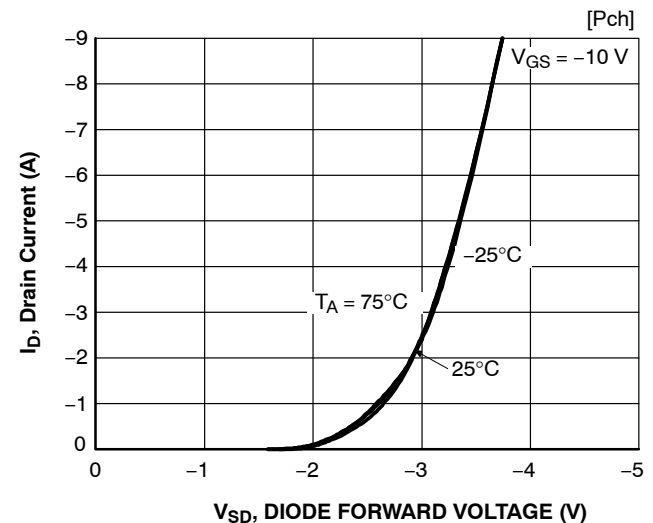
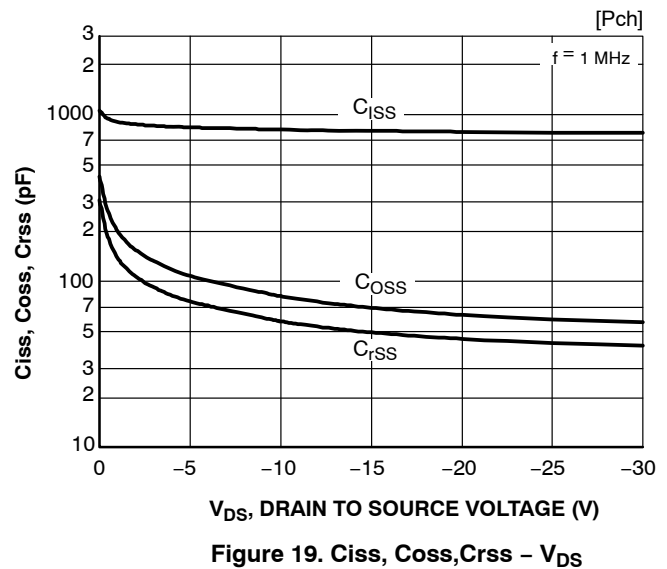
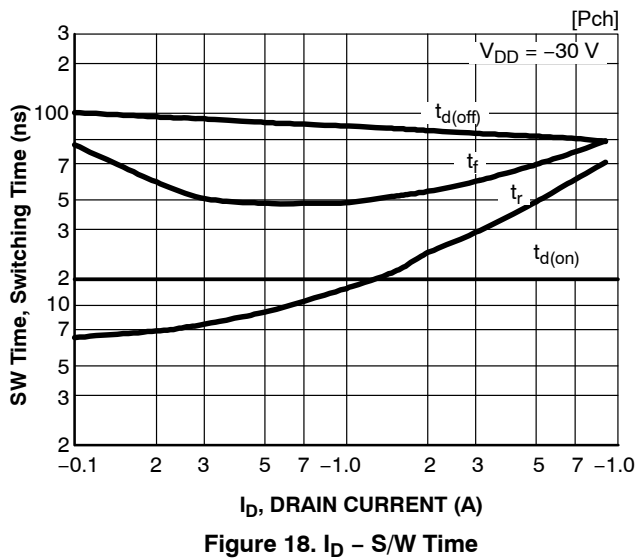
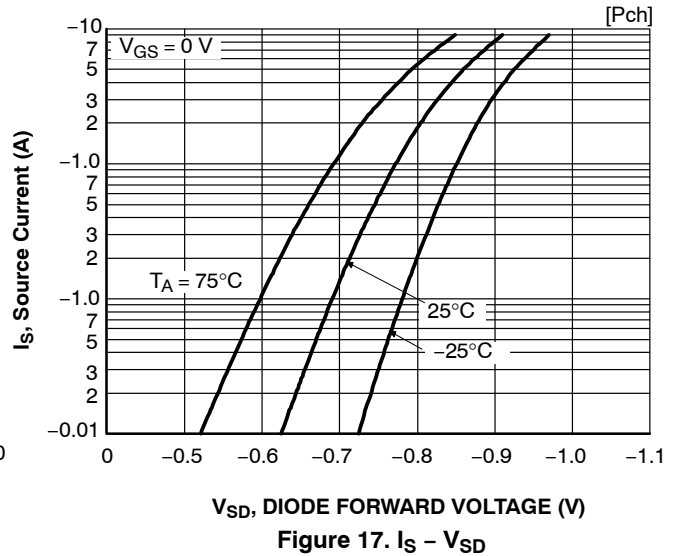
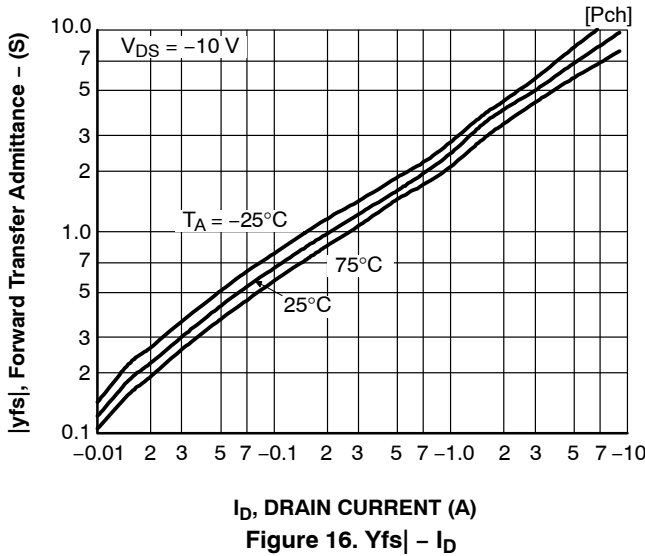
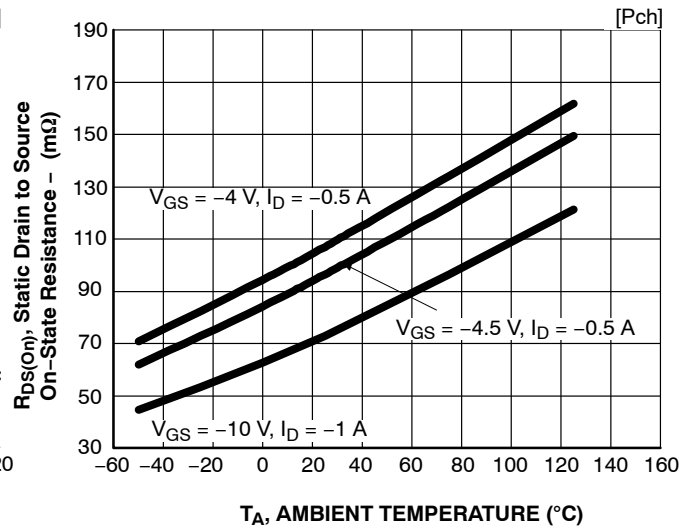
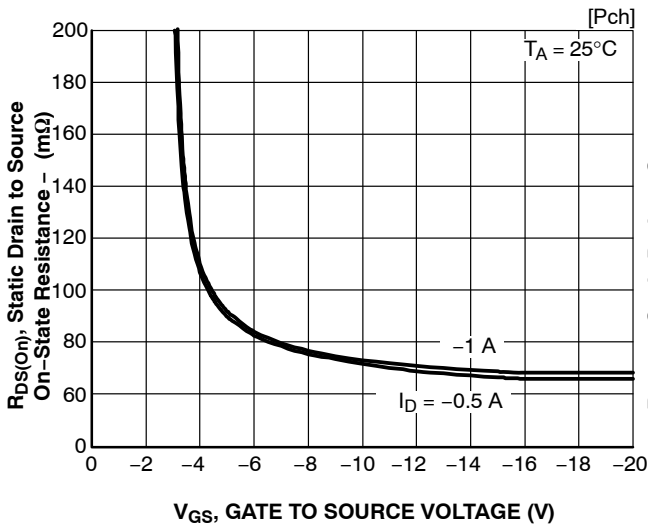


Figure 13. I_D - V_{GS}

TYPICAL CHARACTERISTICS (CONTINUED)



TYPICAL CHARACTERISTICS (CONTINUED)

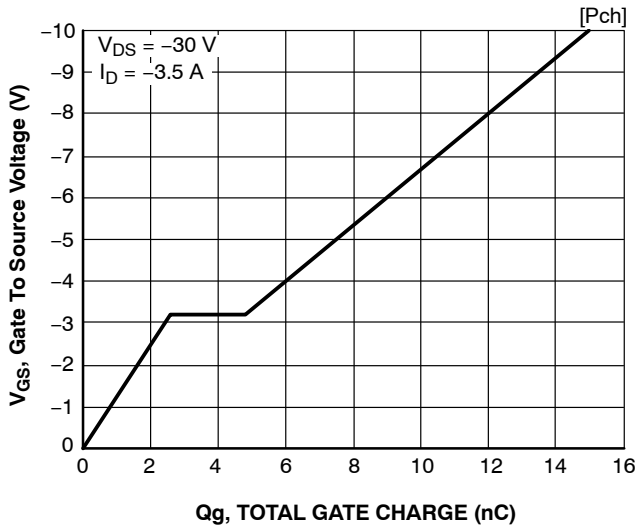


Figure 20. $V_{GS} - Q_g$

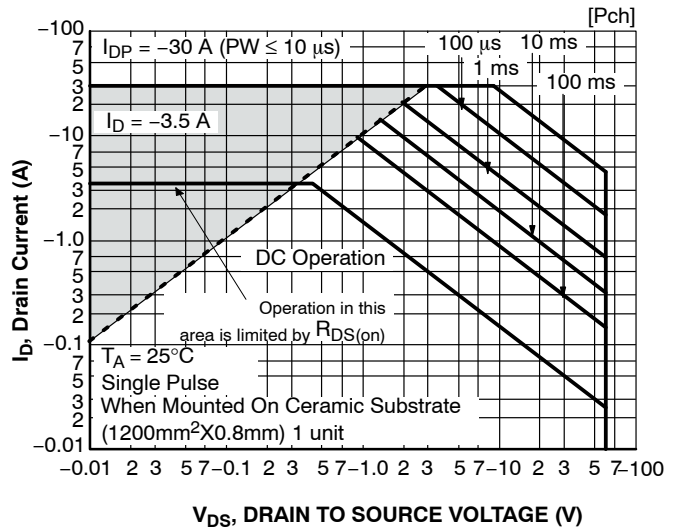


Figure 21. S O A

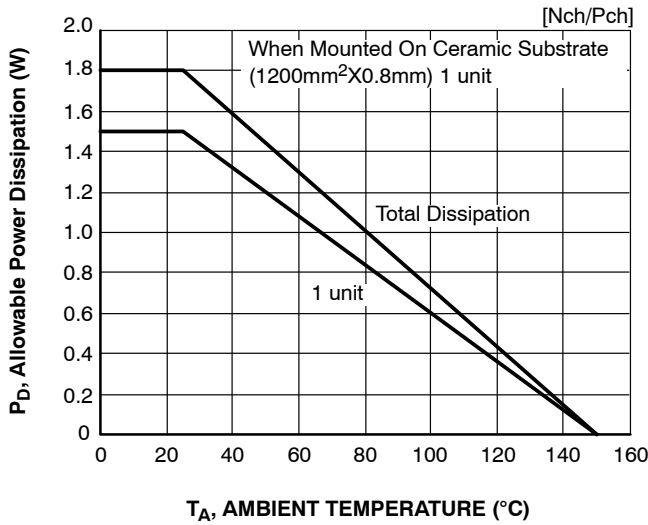


Figure 22. $P_D - T_A$

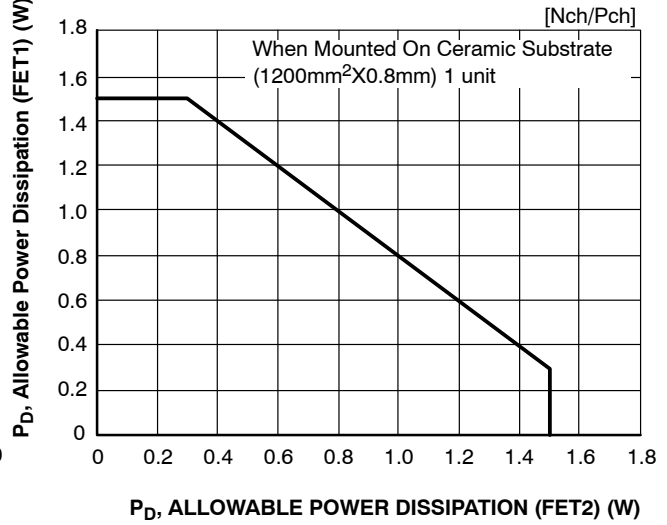


Figure 23. P_D (FET1) - P_D (FET2)

ORDERING INFORMATION

Product Number	Package	Shipping†
ECH8690-TL-H	SOT-28FL / ECH8 (Pb-Free / Halogen Free)	3000 / Tape and Reel

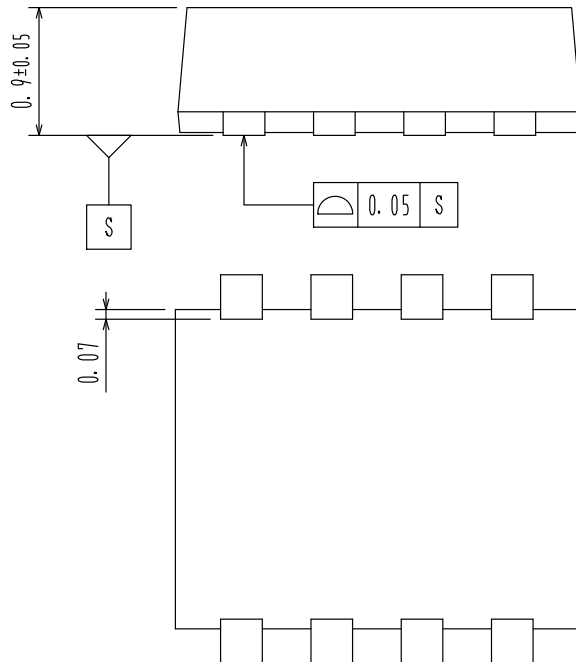
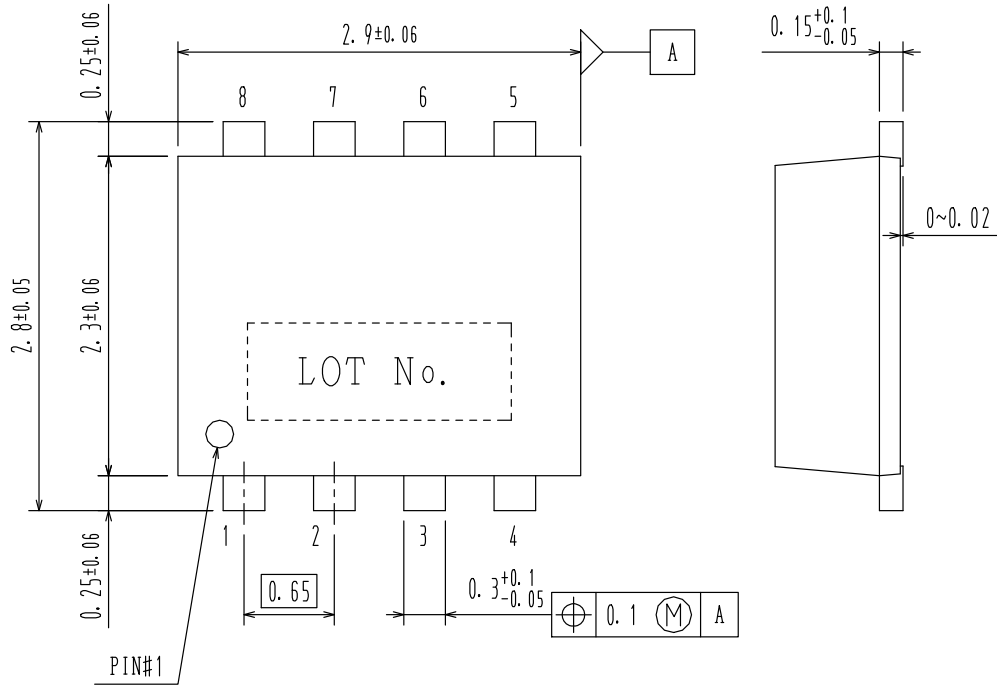
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, [BRD8011/D](#).

Note on usage : Since the ECH8690 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects. Please contact sales for use except the designated application.

MECHANICAL CASE OUTLINE
PACKAGE DIMENSIONS

SOT-28FL / ECH8
CASE 318BF
ISSUE O

DATE 31 MAR 2012



DOCUMENT NUMBER:	98AON78700E	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
DESCRIPTION:	SOT-28FL / ECH8	PAGE 1 OF 1

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, **Onsemi**, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "**onsemi**" or its affiliates and/or subsidiaries in the United States and/or other countries. **onsemi** owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of **onsemi**'s product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. **onsemi** reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and **onsemi** makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation
onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at www.onsemi.com/support/sales